

# SS34-320

Schottky Barrier Diode



## Features

- For surface mounted applications
- Low power loss, high efficiency
- High forward surge current capability
- For use in low voltage, high frequency inverters,
- free wheeling, and polarity protection applications
- Metal silicon junction, majority carrier conduction
- Approx. Weight : 15mg



Pb Free

ROHS Compliant

Green Product

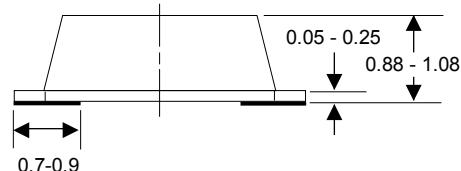
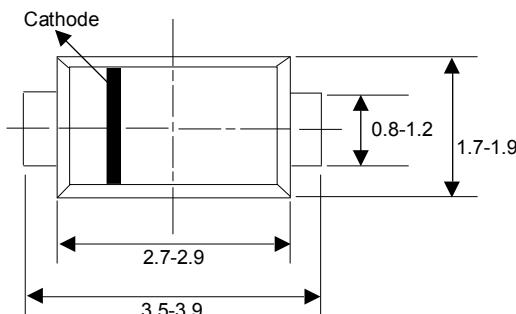
## Making :

SS34	K34
SS36	K36
SS310	K310
SS320	K320



## PACKAGE DIMENSIONS in millimeters (mm):

### SOD-123F



Packing : 3000pcs/reel

## Maximum Ratings And Electrical Characteristics (Ta=25°C unless otherwise noted)

Parameter	Symbols	SS34	SS36	SS310	SS320	Units
Maximum Repetitive Peak Reverse Voltage	V <sub>RRM</sub>	40	60	100	200	V
Maximum RMS voltage	V <sub>RMS</sub>	28	42	70	140	V
Maximum DC Blocking Voltage	V <sub>DC</sub>	40	60	100	200	V
Maximum Average Forward Rectified Current	I <sub>F(AV)</sub>			3.0		A
Peak Forward Surge Current, 8.3ms Single Half Sine-wave Superimposed on Rated Load (JEDEC method)	I <sub>FSM</sub>			80		A
Max Instantaneous Forward Voltage at 3A	V <sub>F</sub>	0.55	0.70	0.85	0.95	V
Maximum DC Reverse Current T <sub>a</sub> = 25°C At Rated DC Reverse Voltage T <sub>a</sub> = 100°C	I <sub>R</sub>	0.5 10		0.3 5		mA
Typical Junction Capacitance <sup>(1)</sup>	C <sub>j</sub>	250		160		pF
Typical Thermal Resistance <sup>(2)</sup>	R <sub>θJA</sub>		80			°C/W
Operating Junction Temperature Range	T <sub>j</sub>		-55 ~ +125			°C
Storage Temperature Range	T <sub>stg</sub>		-55 ~ +150			°C

(1)Measured at 1 MHz and applied reverse voltage of 4 V D.C.

(2)P.C.B. mounted with 2.0" X 2.0" (5 X 5 cm) copper pad areas.

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## Typical Characteristics

Fig.1 Forward Current Derating Curve

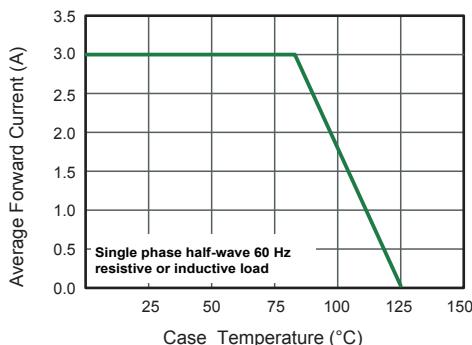


Fig.2 Typical Reverse Characteristics

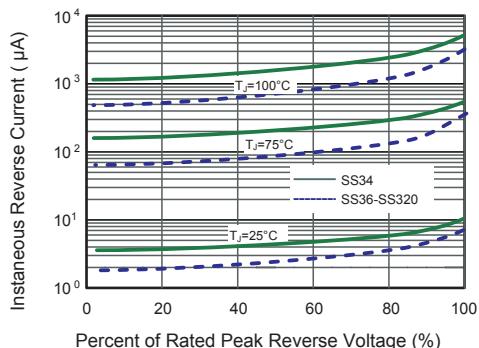


Fig.3 Typical Forward Characteristic

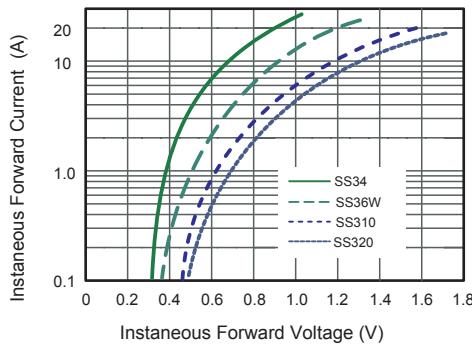


Fig.4 Typical Junction Capacitance

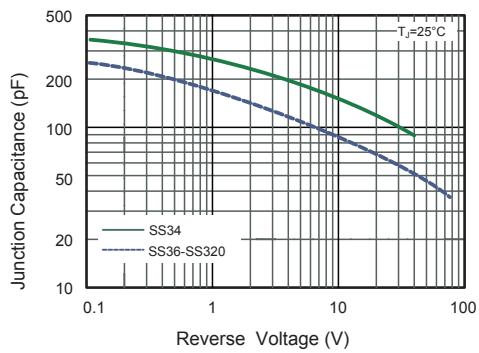


Fig.5 Maximum Non-Repetitive Peak Forward Surge Current

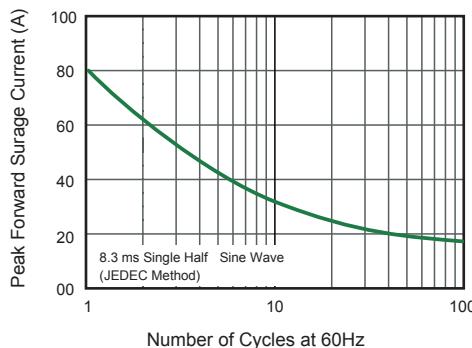


Fig.6- Typical Transient Thermal Impedance

